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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAF2002

Silicon N Channel MOS FET Series Power Switching

REJ03G1135-0300

(Previous: ADE-208-503A)

Rev.3.00 Sep 07, 2005

Description

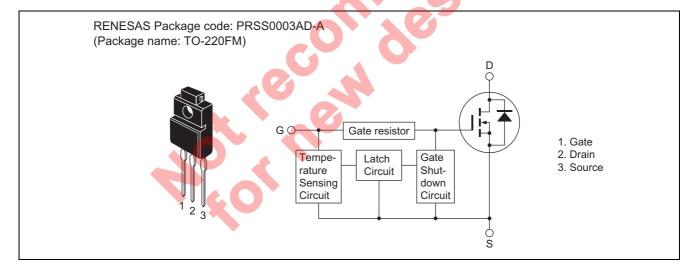
This FET has the over temperature shut-down capability sensing to the junction temperature.

This FET has the built-in over temperature shut-down circuit in the gate area. And this circuit operation to shut-down the gate voltage in case of high junction temperature like applying over power consumption, over current etc.

Features

- Logic level operation (4 to 6 V Gate drive)
- High endurance capability against to the short circuit
- Built-in the over temperature shut-down circuit
- Latch type shut-down operation (Need 0 voltage recovery)

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit	
Drain to source voltage	V _{DSS}	60	V	
Gate to source voltage	V _{GSS}	16	V	
	V _{GSS}	-2.8	V	
Drain current	I _D	20	Α	
Drain peak current	I _{D (pulse)} Note 1	40	Α	
Body-drain diode reverse drain current	I _{DR}	20	Α	
Channel dissipation	Pch Note 2	30	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Ta = 25°C

Typical Operation Characteristics

Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Input voltage	V_{IH}	3.5		1	V		
	V_{IL}	_		1.2	V		
Input current	I _{IH1}	_	_	100	μΑ	$Vi = 8 V, V_{DS} = 0$	
(Gate non shut down)	I _{IH2}	_		50	μΑ	$Vi = 3.5 V, V_{DS} = 0$	
	I_{IL}	_	1	1	μΑ	$Vi = 1.2 V, V_{DS} = 0$	
Input current	I _{IH (sd) 1}		0.8		mA	$Vi = 8 V, V_{DS} = 0$	
(Gate shut down)	I _{IH (sd) 2}		0.35	Y	mA	$Vi = 3.5 V, V_{DS} = 0$	
Shut down temperature	Tsd		175		°C	Channel temperature	
Gate operation voltage	V _{OP}	3.5		13	V		

Electrical Characteristics

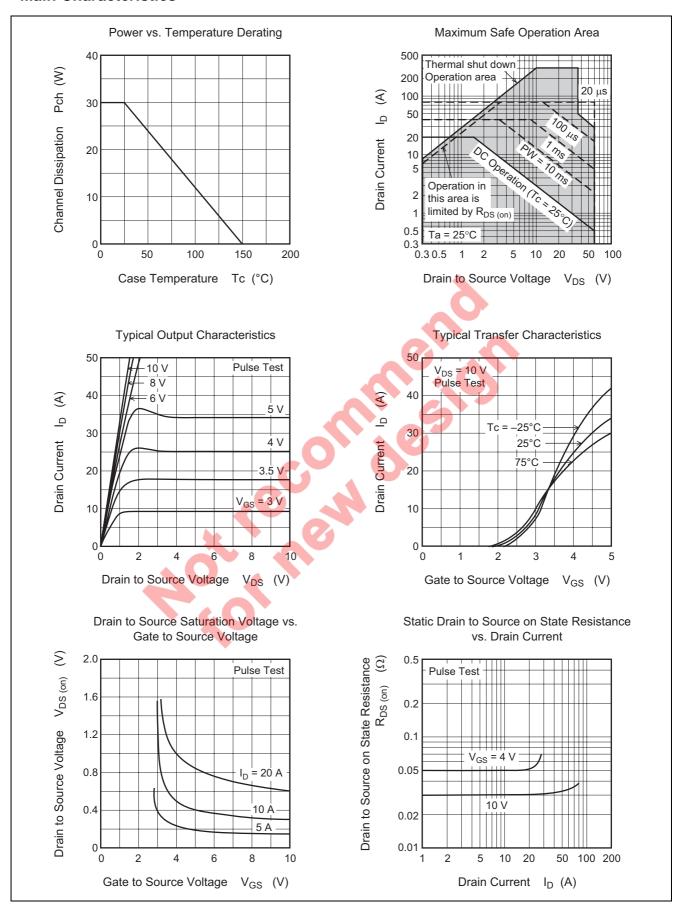
 $(Ta = 25^{\circ}C)$

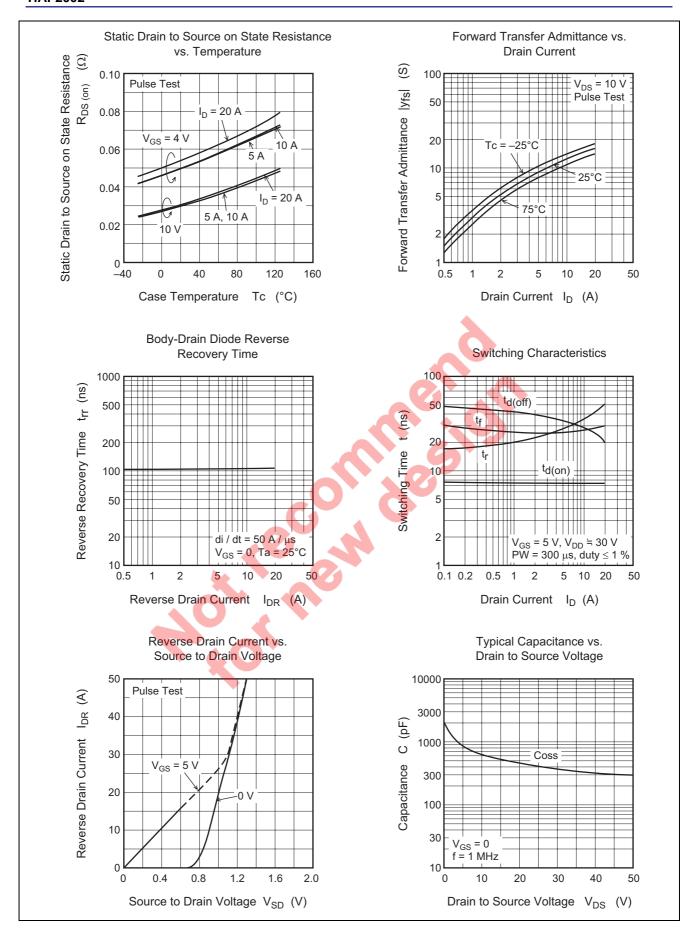
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain current	I _{D1}	10	_	_	Α	$V_{GS} = 3.5 \text{ V}, V_{DS} = 2 \text{ V}$
	I _{D2}	_	_	10	mA	V _{GS} = 1.2 V, V _{DS} = 2 V
Drain to source breakdown voltage	V (BR) DSS	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR) GSS}	16	_	_	V	$I_G = 100 \mu A, V_{DS} = 0$
	$V_{(BR)GSS}$	-2.8	_	_	V	$I_G = -100 \mu\text{A}, V_{DS} = 0$
Gate to source leak current	I _{GSS1}	_	_	100	μΑ	$V_{GS} = 8 \text{ V}, V_{DS} = 0$
	I _{GSS2}	_	_	50	μΑ	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
	I _{GSS3}	_	_	1	μΑ	$V_{GS} = 1.2 \text{ V}, V_{DS} = 0$
	I _{GSS4}	_	_	-100	μΑ	$V_{GS} = -2.4 \text{ V}, V_{DS} = 0$
Input current (shut down)	I _{GS (op) 1}	_	0.8	_	mA	$V_{GS} = 8 \text{ V}, V_{DS} = 0$
	I _{GS (op) 2}		0.35		mA	$V_{GS} = 3.5 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}		_	250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS (off)}$	1.0	_	2.25	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS (on)}	_	50	65	mΩ	$I_D = 10 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note 3}}$
	R _{DS (on)}		30	43	mΩ	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 3}}$
Forward transfer admittance	y _{fs}	6	12	d	S	$I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Output capacitance	Coss		630		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0$
						f = 1 MHz
Turn-on delay time	t _{d (on)}		7.5	J	μs	I _D = 5 A
Rise time	t _r		29	1	μs	$V_{GS} = 5 \text{ V}$
Turn-off delay time	t _{d (off)}		34	5	μs	$R_L = 6 \Omega$
Fall time	t _f)	26	1	μs	
Body-drain diode forward voltage	V_{DF}	<u> </u>	1.0	_	V	$I_F = 20 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t _{rr}	_	110	_	ns	$I_F = 20 \text{ A}, V_{GS} = 0$
						$di_F/dt = 50 A/\mu s$
Over load shut down operation time Note4	t _{os1}		1.8	_	ms	$V_{GS} = 5 \text{ V}, V_{DD} = 12 \text{ V}$
	t _{os2}		0.7	_	ms	$V_{GS} = 5 \text{ V}, V_{DD} = 24 \text{ V}$

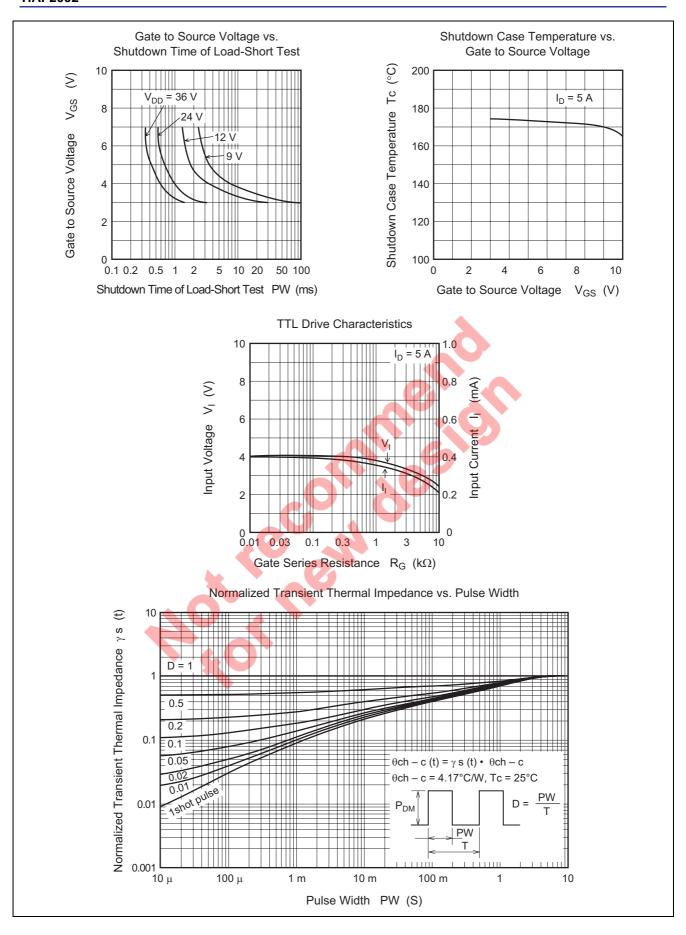
Notes: 3. Pulse test

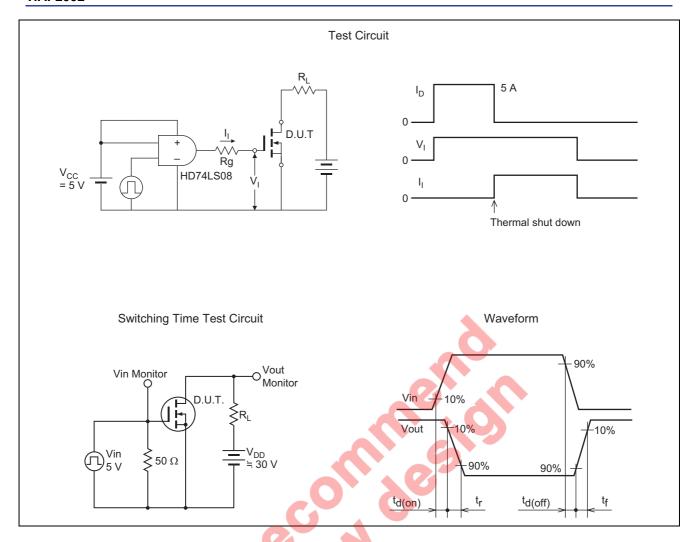
4. Include the time shift based on increasing of channel temperature when operate under over load condition.

Main Characteristics

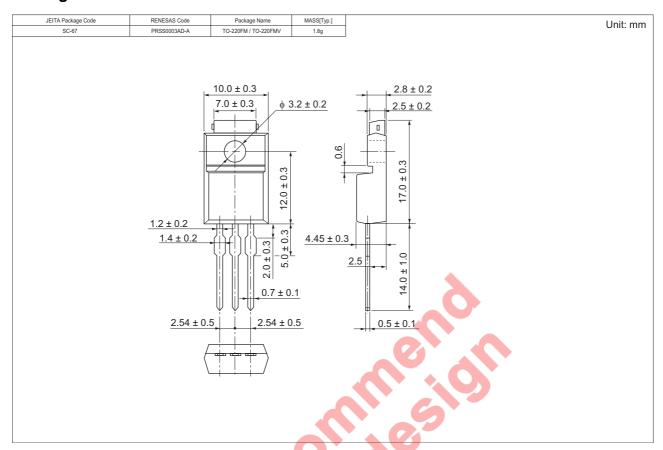








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAF2002-90	Max: 50 pcs/sack	Sack

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